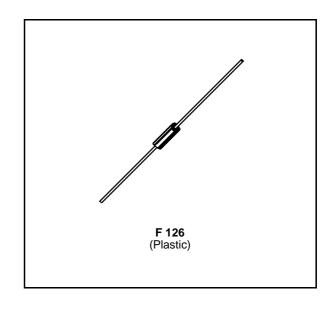


FAST RECOVERY RECTIFIER DIODES

FAST RECOVERY RECTIFIER

- VERY LOW REVERSE RECOVERY TIME
- VERY LOW SWITCHING LOSSES
- LOW NOISE TURN-OFF SWITCHING



SUITABLE APPLICATION

- FREE WHEELING DIODE IN CONVERTERS AND MOTORS CIRCUITS
- RECTIFIER IN S.M.P.S.

ABSOLUTE RATINGS (limiting values)

Symbol	Parameter	Value	Unit	
I _{FRM}	Repetive Peak Forward Current	$t_p \le 10 \mu s$	30	Α
I _{F (AV)}	Average Forward Current*	$T_a = 70^{\circ}C$ $\delta = 0.5$	1	Α
I _{FSM}	Surge non Repetitive Forward Current	t _p = 10ms Sinusoidal	30	А
Р	Power Dissipation*	Ta = 70°C	1.33	W
T _{stg} T _j	Storage and Junction Temperature Range		- 40 to +150 - 40 to + 150	°C

Symbol	Parameter	Value	Unit
V_{RRM}	Repetitive Peak Reverse Voltage	400	V
V_{RSM}	Non Repetitive Peak Reverse Voltage	440	V

THERMAL RESISTANCE

Symbol	Parameter	Value	Unit
R _{th (j - a)}	Junction-ambient*	60	°C/W

^{*} On infinite heatsink with 10mm lead length.

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ELECTRICAL CHARACTERISTICS

STATIC CHARACTERISTICS

Symbol		Min.	Тур.	Max.	Unit	
I _R	T _j = 25°C	$V_R = V_{RRM}$			20	μΑ
	T _j = 100°C				0.5	mA
V _F	T _j = 25°C	I _F = 1A			1.5	V
	T _j = 100°C				1.4	

RECOVERY CHARACTERISTICS

Symbol	Test Conditions					Тур.	Max.	Unit
t _{rr}	T _j = 25°C	I _F = 1A	$di_F/dt = -15A/\mu s$	$V_R = 30V$			55	ns
	T _j = 25°C	I _F = 0.5A	I _R = 1A	$I_{rr} = 0.25A$			25	

TURN-OFF SWITCHING CHARACTERISTICS (Without Series inductance)

Symbol	Test Conditions				Min.	Тур.	Max.	Unit
t _{IRM}	$di_F/dt = -50A/\mu s$	T _j = 100°C	V _{CC} = 200 V	I _F = 1A		35	50	ns
I _{RM}	di _F /dt = - 50A/μs	$L_p \le 0.05 \; \mu A$	See figure 12			1.5	2	Α

To evaluate the conduction losses use the following equations:

$$V_F = 1.05 + 0.145 I_F$$
 $P = 1.05 \times I_{F(AV)} + 0.145 I_{F^2(RMS)}$

Figure 1. Maximum average power dissipation versus average forward current.

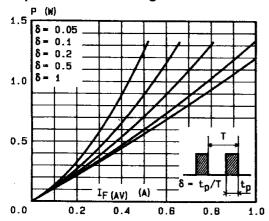


Figure 2. Average forward current versus ambient temperature.

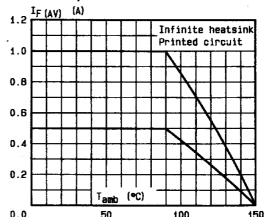
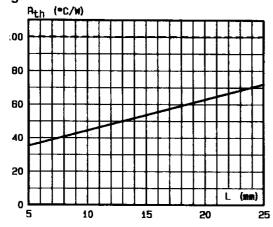


Figure 3. Thermal resistance versus lead length.



Mounting n°1
INFINITE HEATSINK

Mounting n°2 PRINTED CIRCUIT

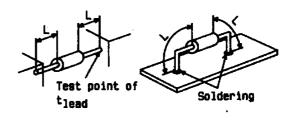


Figure 4. Transient thermal impedance junction-ambient for mounting n^2 versus pulse duration (L = 10 mm).

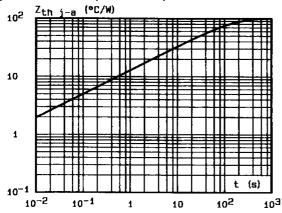


Figure 5. Peak forward current versus peak forward voltage drop (maximum values).

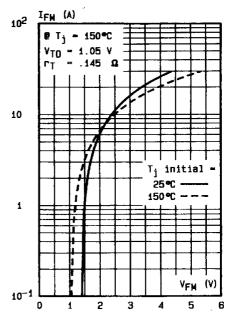


Figure 7. Recovery time versus di_F/dt.

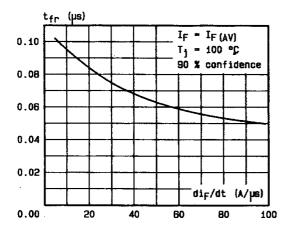


Figure 8. Peak forward voltage versus di \digamma /dt.

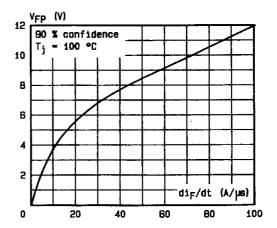


Figure 9. Peak reverse current versus dif/dt.

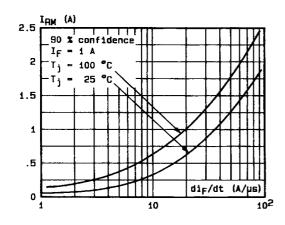


Figure 10. Recovered charge versus di_F/dt (typical values).

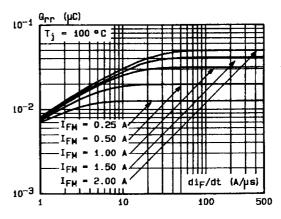


Figure 11. Dynamic parameters versus junction temperature.

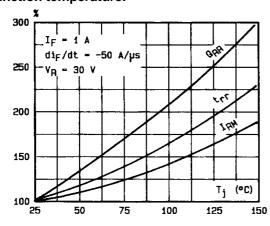
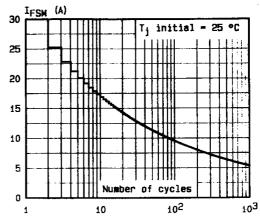


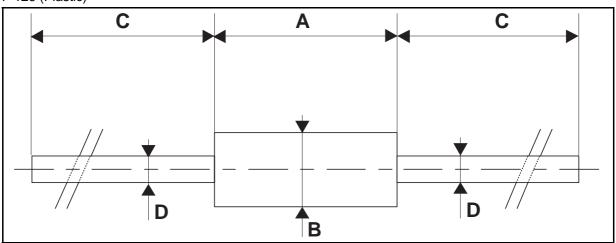
Figure 12. Non repetitive surge peak current versus number of cycles.



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PACKAGE MECHANICAL DATA

F 126 (Plastic)



REF.	DIMENSIONS							
	Mi	illimete	ers		Inches	i		
	Min.	Тур.	Max.	. Min. Typ. Ma				
Α	6.05	6.20	6.35	0.238	0.244	0.250		
В	2.95	3.00	3.05	0.116	0.118	0.120		
С	26		31	1.024		1.220		
D	0.76	0.81	0.86	0.030	0.032	0.034		

■ Marking: type number

■ Cooling method: by convection (method A)

■ Weight: 0.393g

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